

# **N-Channel Depletion-Mode Vertical DMOS FETs**

#### **Features**

- ▶ High input impedance
- Low input capacitance
- Fast switching speeds
- Low on resistance
- Free from secondary breakdown
- Low input and output leakage

#### **Applications**

- Normally-on switches
- Solid state relays
- Converters
- Constant current sources
- Power supply circuits
- ▶ Telecom

#### **General Description**

The Supertex DN3145 is a depletion-mode (normally-on) transistor utilizing an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

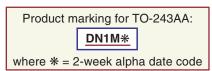
Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

#### **Ordering Information**

BV <sub>DSX</sub> /	R <sub>DS(ON)</sub>	l <sub>nee</sub>	Package Options		
BV <sub>DGX</sub>	(max)	"DSS (min)	TO-243AA1		
450V	60Ω	120mA	DN3145N8		
			DN3145N8-G		

-G indicates package is RoHS compliant ('Green')

Notes: 1Same as SOT-89.



### **Absolute Maximum Ratings**

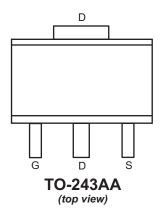
Parameter	Value		
Drain-to-source voltage	BV <sub>DSX</sub>		
Drain-to-gate voltage	BV <sub>DGX</sub>		
Gate-to-source voltage	±20V		
Operating and storage temperature	-55°C to +150°C		
Soldering temperature*	300°C		

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.





### **Pin Configuration**



<sup>\*</sup>Distance of 1.6mm from case for 10 seconds.

#### **Thermal Characteristics**

Package	I <sub>D</sub> (continuous)¹	I <sub>D</sub> (pulsed)	Power Dissipation @T <sub>A</sub> = 25°C	Θ <sub>jc</sub> (°C/W)	Θ <sub>ja</sub> (°C/W)	l <sub>DR</sub> <sup>1</sup>	I <sub>DRM</sub>
TO-243AA	100mA	300mA	1.3W <sup>2</sup>	34	972	100mA	300mA

#### Notes:

- 1.  $I_D$  (continuous) is limited by max rated  $T_D$
- 2. Mounted on FR4 board, 25mm x 25mm x 1.57mm. Significant  $P_{\scriptscriptstyle D}$  increase possible on ceramic substrate.

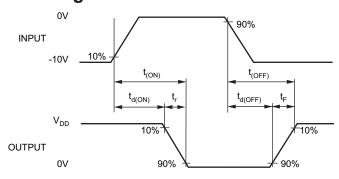
## Electrical Characteristics (@25°C unless otherwise specified)

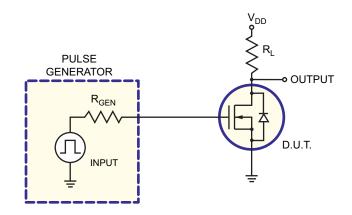
Symbol	Parameter	Min	Тур	Max	Units	Conditions	
_		450	136	- -	V		
BV <sub>DSX</sub>	Drain-to-source breakdown voltage		-			$V_{GS} = -5.0V, I_{D} = 100\mu A$	
V <sub>GS(OFF)</sub>	Gate-to-source OFF voltage	-1.5	-	-3.5	V	$V_{DS} = 15V, I_{D} = 10\mu A$	
$\Delta V_{GS(OFF)}$	Change in V <sub>GS(OFF)</sub> with temperature	-	-	4.5	mV/°C	$V_{DS} = 15V, I_{D} = 10\mu A$	
I <sub>GSS</sub>	Gate body leakage current	-	-	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
		-	-	1.0	μA	$V_{DS}$ = Max rating, $V_{GS}$ = -5.0V	
l <sub>D(OFF)</sub>	Drain-to-source leakage current	ı	-	1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = -5.0$ V, $T_{A} = 125$ °C	
I <sub>DSS</sub>	Saturated drain-to-source current	120	-	-	mA	$V_{GS} = 0V, V_{DS} = 15V$	
R <sub>DS(ON)</sub>	Static drain-to-source ON-state resistance	ı	-	60	Ω	V <sub>GS</sub> = 0V, I <sub>D</sub> = 100mA	
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with temperature	-	-	1.1	%/°C	$V_{GS} = 0V, I_D = 100mA$	
G <sub>FS</sub>	Forward transconductance	140	-	-	mmho	$V_{DS} = 10V, I_{D} = 100mA$	
C <sub>ISS</sub>	Input capacitance	-	-	120		V <sub>GS</sub> = -5.0V,	
C <sub>oss</sub>	Common source output capacitance	-	-	15	pF	V <sub>DS</sub> = 25V, f = 1.0MHz	
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	10			
t <sub>d(ON)</sub>	Turn-ON delay time	-	-	10		$V_{DD} = 25V,$ $I_{D} = 100\text{mA},$ $R_{GEN} = 25\Omega,$	
t <sub>r</sub>	Rise time	-	-	15			
t <sub>d(OFF)</sub>	Turn-OFF delay time	-	-	20	ns		
t <sub>f</sub>	Fall time	-	-	35			
V <sub>SD</sub>	Diode forward voltage drop	-	-	1.8	V	V <sub>GS</sub> = -5.0V, I <sub>SD</sub> = 100mA	
t <sub>rr</sub>	Reverse recovery time	-	800	-	ns	V <sub>GS</sub> = -5.0V, I <sub>SD</sub> = 100mA	

#### Notes:

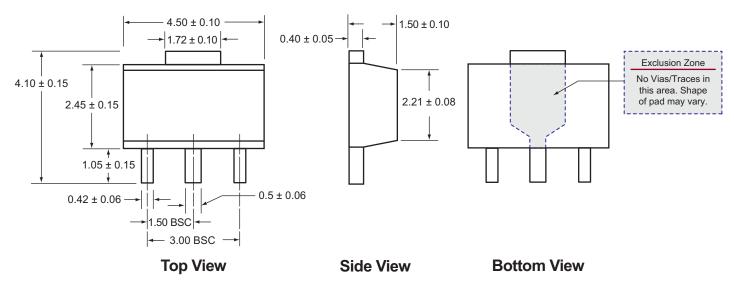
- 1.All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2.All A.C. parameters sample tested.

## **Switching Waveforms and Test Circuit**





# 3-Lead TO-243AA (SOT-89) Surface Mount Package (N8)



Notes:

All dimensions are in millimeters; all angles in degrees.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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